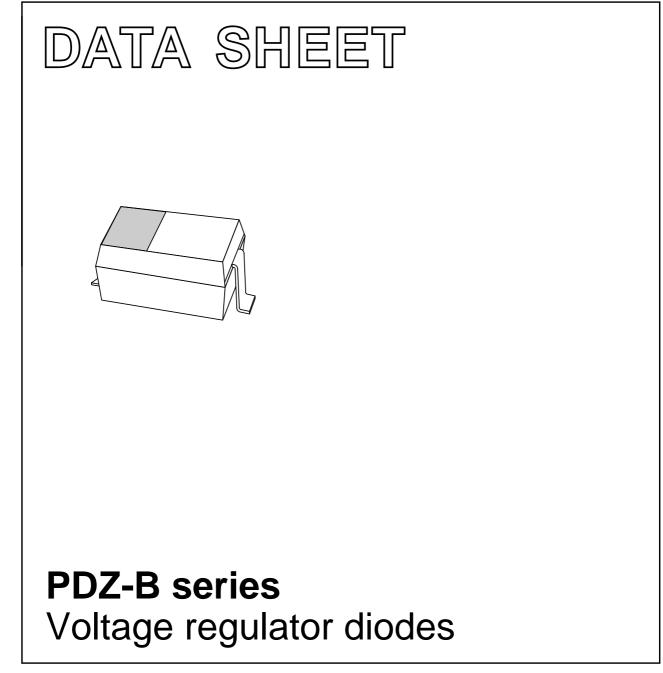
DISCRETE SEMICONDUCTORS



Product specification Supersedes data of 1998 Apr 23 2002 Feb 18



FEATURES

- Total power dissipation: max. 400 mW
- Small plastic package suitable for surface mounted design
- Wide variety of voltage ranges: nom. 2.4 to 36 V (E24 range)
- Tolerance approximately ±2%.

APPLICATIONS

• General voltage regulation.

DESCRIPTION

Low-power general purpose voltage regulator diodes in a small plastic SMD SOD323 package.

MARKING

PINNING

PIN	DESCRIPTION				
1	cathode				
2	anode				

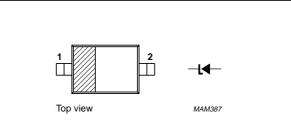


Fig.1 Simplified outline (SOD323) and symbol.

TYPE NUMBER	MARKING CODE	TYPE NUMBER	MARKING CODE	TYPE NUMBER	MARKING CODE	TYPE NUMBER	MARKING CODE
PDZ2.4B	Z0	PDZ5.1B	Z8	PDZ11B	ZG	PDZ24B	ZQ
PDZ2.7B	Z1	PDZ5.6B	Z9	PDZ12B	ZH	PDZ27B	ZR
PDZ3.0B	Z2	PDZ6.2B	ZA	PDZ13B	ZJ	PDZ30B	ZS
PDZ3.3B	Z3	PDZ6.8B	ZB	PDZ15B	ZK	PDZ33B	ZT
PDZ3.6B	Z4	PDZ7.5B	ZC	PDZ16B	ZL	PDZ36B	ZU
PDZ3.9B	Z5	PDZ8.2B	ZD	PDZ18B	ZM		
PDZ4.3B	Z6	PDZ9.1B	ZE	PDZ20B	ZN		
PDZ4.7B	Z7	PDZ10B	ZF	PDZ22B	ZP		

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
IF	continuous forward current		-	200	mA
I _{ZSM}	non-repetitive peak reverse current	$t_p = 100 \ \mu s$; square wave; $T_{amb} = 25 \ ^{\circ}C$ prior to surge	ę	see Table :	2
P _{tot}	total power dissipation	T _{amb} = 25 °C; note 1; see Fig.2	_	400	mW
T _{stg}	storage temperature		-65	+150	°C
Tj	junction temperature		-	150	°C

Note

1. Device mounted on a printed-circuit board measuring $11 \times 25 \times 1.6$ mm.

PDZ-B series

PDZ-B series

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R _{th j-s}	thermal resistance from junction to soldering point		130	K/W
R _{th j-a}	thermal resistance from junction to ambient	note 1	340	K/W

Note

1. Device mounted on a printed-circuit board measuring $11 \times 25 \times 1.6$ mm.

CHARACTERISTICS

Table 1 Total series

 $T_j = 25 \ ^{\circ}C$ unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MAX.	UNIT
V _F	forward voltage	I _F = 10 mA; see Fig.3	0.9	V
		I _F = 100 mA; see Fig.3	1.1	V
I _R	reverse current			
	PDZ2.4B	$V_R = 1 V$	50	μA
	PDZ2.7B	$V_R = 1 V$	20	μA
	PDZ3.0B	$V_R = 1 V$	10	μA
	PDZ3.3B	$V_R = 1 V$	5	μA
	PDZ3.6B	$V_R = 1 V$	5	μA
	PDZ3.9B	$V_R = 1 V$	3	μA
	PDZ4.3B	$V_R = 1 V$	3	μA
	PDZ4.7B	$V_R = 1 V$	2	μA
	PDZ5.1B	V _R = 1.5 V	2	μA
	PDZ5.6B	V _R = 2.5 V	1	μA
	PDZ6.2B	$V_R = 3 V$	500	nA
	PDZ6.8B	V _R = 3.5 V	500	nA
	PDZ7.5B	$V_R = 4 V$	500	nA
	PDZ8.2B	$V_{R} = 5 V$	500	nA
	PDZ9.1B	$V_R = 6 V$	500	nA
	PDZ10B	V _R = 7 V	100	nA
	PDZ11B	V _R = 8 V	100	nA
	PDZ12B	V _R = 9 V	100	nA
	PDZ13B	V _R = 10 V	100	nA
	PDZ15B	V _R = 11 V	50	nA
	PDZ16B	V _R = 12 V	50	nA
	PDZ18B	V _R = 13 V	50	nA
	PDZ20B	V _R = 15 V	50	nA
	PDZ22B	V _R = 17 V	50	nA
	PDZ24B	V _R = 19 V	50	nA
	PDZ27B	V _R = 21 V	50	nA
	PDZ30B	V _R = 23 V	50	nA
	PDZ33B	V _R = 25 V	50	nA
	PDZ36B	V _R = 27 V	50	nA

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Product specification

PDZ-B series

Table 2Per type $T_j = 25 \ ^{\circ}C$ unless otherwise specified.

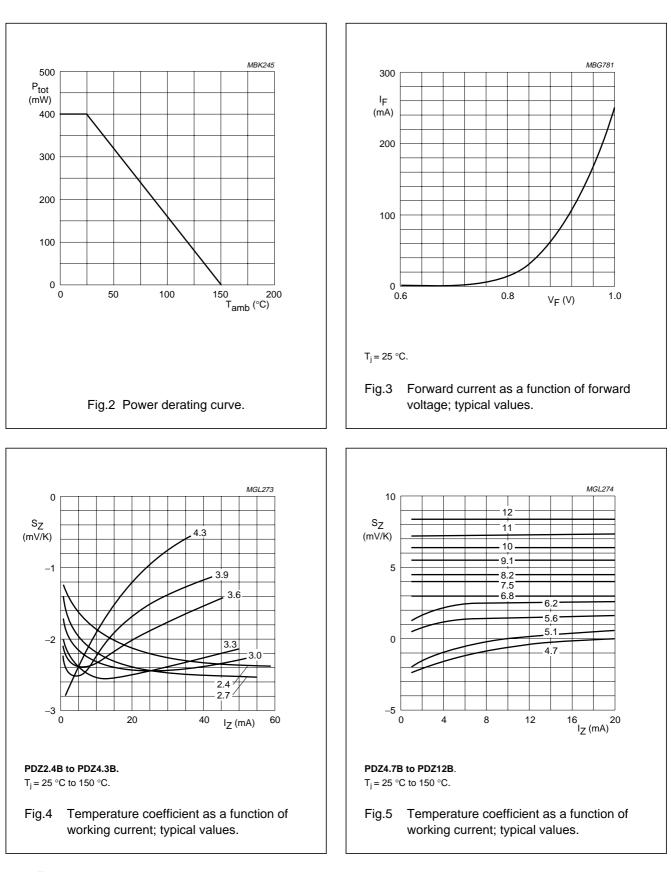
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WORKING VOLTAGETYPENUMBER		DIFFERENTIAL RESISTANCE r _{dif} (Ω)				TEMP. COEFF. S_Z (mV/K) at $I_Z = 5$ mA (see Figs 4 and 5)	DIODE CAP. C _d (pF) at f = 1 MHz; V _R = 0	NON-REPETITIVE PEAK REVERSE CURRENT I_{ZSM} (A) at $t_p = 100 \ \mu s$; $T_{amb} = 25 \ ^{\circ}C$	
	MIN.	MAX.	MAX.	at I _Z (mA)	MAX.	at I _Z (mA)	TYP.	MAX.	MAX.
PDZ2.4B	2.43	2.63	1000	0.5	100	5	-1.6	450	8.0
PDZ2.7B	2.69	2.91	1000	0.5	100	5	-2.0	440	8.0
PDZ3.0B	2.85	3.07	1000	0.5	95	5	-2.1	425	8.0
PDZ3.3B	3.32	3.53	1000	0.5	95	5	-2.4	410	8.0
PDZ3.6B	3.60	3.85	500	1.0	90	5	-2.4	390	8.0
PDZ3.9B	3.89	4.16	500	1.0	90	5	-2.5	370	8.0
PDZ4.3B	4.17	4.48	600	1.0	90	5	-2.5	350	8.0
PDZ4.7B	4.55	4.75	600	1.0	90	5	-1.4	325	8.0
PDZ5.1B	4.96	5.20	250	0.5	60	5	0.3	300	5.5
PDZ5.6B	5.48	5.73	100	0.5	50	5	1.9	275	5.5
PDZ6.2B	6.06	6.33	80	0.5	50	5	2.7	250	5.5
PDZ6.8B	6.65	6.93	60	0.5	40	5	3.4	215	5.5
PDZ7.5B	7.28	7.60	60	0.5	10	5	4.0	170	3.5
PDZ8.2B	8.02	8.36	60	0.5	10	5	4.6	150	3.5
PDZ9.1B	8.85	9.23	60	0.5	10	5	5.5	120	3.5
PDZ10B	9.77	10.21	60	0.5	10	5	6.4	110	3.5
PDZ11B	10.78	11.22	60	0.5	10	5	7.4	108	3.0
PDZ12B	11.74	12.24	80	0.5	10	5	8.4	105	3.0
PDZ13B	12.91	13.49	80	0.5	10	5	9.4	103	2.5
PDZ15B	14.34	14.98	80	0.5	15	5	11.4	99	2.0
PDZ16B	15.85	16.51	80	0.5	20	5	12.4	97	1.5
PDZ18B	17.56	18.35	80	0.5	20	5	14.4	93	1.5
PDZ20B	19.52	20.39	100	0.5	20	5	16.4	88	1.5
PDZ22B	21.54	22.47	100	0.5	25	5	18.4	84	1.3
PDZ24B	23.72	24.78	120	0.5	30	5	20.4	80	1.3
PDZ27B	26.19	27.53	150	0.5	40	5	23.4	73	1.0
PDZ30B	29.19	30.69	200	0.5	40	5	26.6	66	1.0
PDZ33B	32.15	33.79	250	0.5	40	5	29.7	60	0.9
PDZ36B	35.07	36.87	300	0.5	60	5	33.0	59	0.8

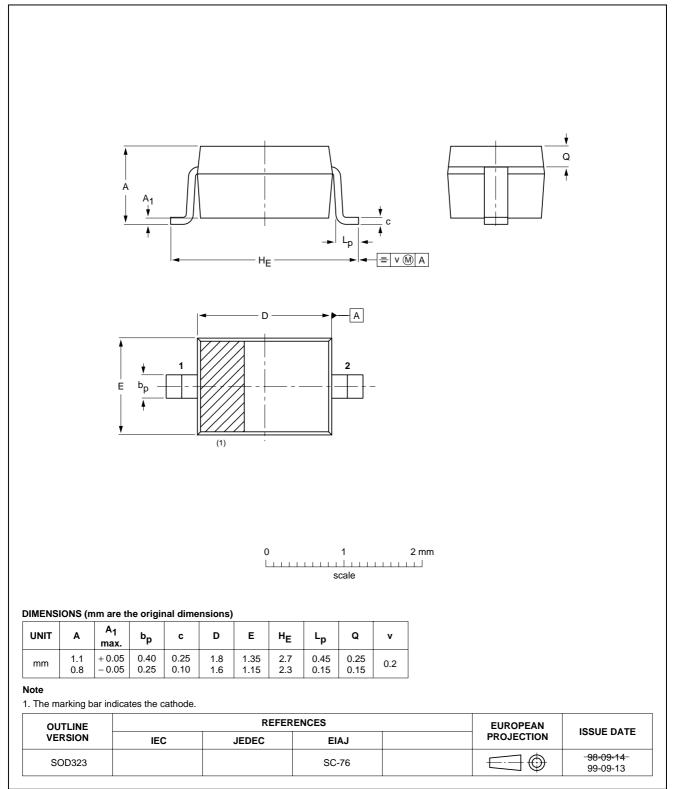
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PDZ-B series



PACKAGE OUTLINE

Plastic surface mounted package; 2 leads



SOD323

PDZ-B series

PDZ-B series

DATA SHEET STATUS

DATA SHEET STATUS ⁽¹⁾	PRODUCT STATUS ⁽²⁾	DEFINITIONS
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Printed in The Netherlands

613510/04/pp**8**

Date of release: 2002 Feb 18

Document order number: 9397 750 09335

SCA74

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